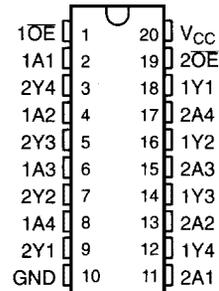


SN74LVC240 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

JANUARY 1993

- **Space-Saving Package Option:**
Shrink Small-Outline Package (DB)
Features EIAJ 0.65-mm Lead Pitch
- **EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process**
- **Designed to Facilitate Incident Wave Switching for Line Impedances of 50 Ω or Greater**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$**
- **Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17**
- **Package Options Include Plastic Small-Outline and Thin Shrink Small-Outline Packages**

DB, DW, OR PW PACKAGE
(TOP VIEW)



description

This octal buffer/driver is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74LVC240 is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The SN74LVC240 is organized as two 4-bit buffers/line drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

The SN74LVC240 is packaged in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN74LVC240 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each buffer)

INPUTS		OUTPUT
\overline{OE}	A	Y
L	H	L
L	L	H
H	X	Z

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TEXAS
INSTRUMENTS

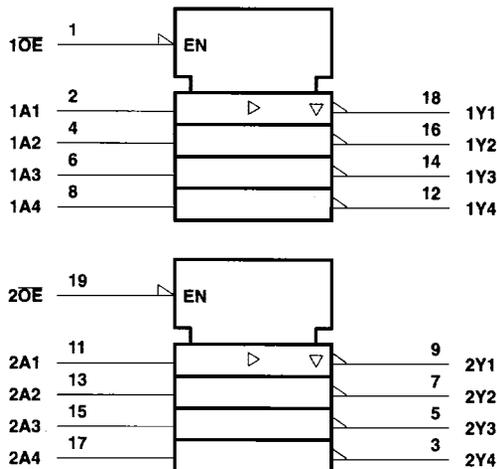
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PRODUCT PREVIEW

SN74LVC240 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

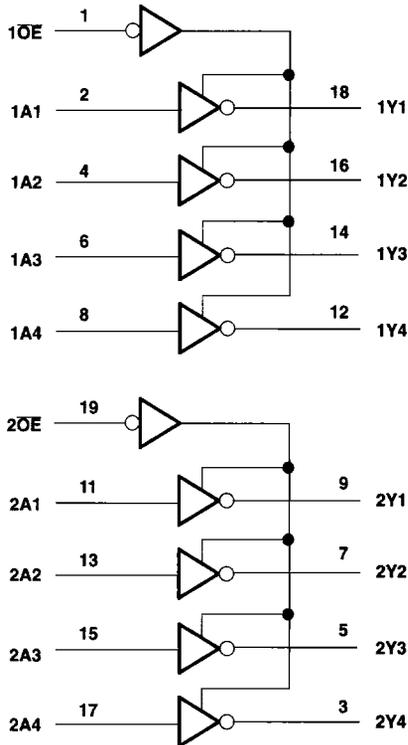
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



PRODUCT PREVIEW

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC}	-0.5 V to 4.6 V
Input voltage range, V_I (see Note 1)	-0.5 V to 4.6 V
Output voltage range, V_O (see Notes 1 and 2)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	-50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 50 mA
Continuous current through V_{CC} or GND pins	± 100 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air):	
DB package	0.5 W
DW package	0.85 W
PW package	0.5 W
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 4.6 V maximum.

SN74LVC240
OCTAL BUFFER/DRIVER
WITH 3-STATE OUTPUTS
 JANUARY 1993

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
V _{CC}	Supply voltage	2.7	3.6	V
V _{IH}	High-level input voltage	V _{CC} = 2.7 V to 3.6 V		V
V _{IL}	Low-level input voltage	V _{CC} = 2.7 V to 3.6 V		V
V _I	Input voltage	0	V _{CC}	V
V _O	Output voltage	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2.7 V		-12
		V _{CC} = 3 V		-24†
I _{OL}	Low-level output current	V _{CC} = 2.7 V		12
		V _{CC} = 3 V		24†
ΔV/Δv	Input transition rise or fall rate	0	10	ns/V
T _A	Operating free-air temperature	-40	85	°C

NOTE 3: Unused or floating inputs must be held high or low.

† Current duty cycle ≤ 50%, f ≥ 1 kHz

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC} ‡	MIN	TYP	MAX	UNIT
V _{IK}	I _I = -18 mA	2.7 V			-1.2	V
V _{OH}	I _{OH} = -100 μA	MIN to MAX	V _{CC} - 0.2			V
	I _{OH} = -12 mA	2.7 V	2.2			
		3 V	2.4			
	I _{OH} = -24 mA	3 V	2			
V _{OL}	I _{OL} = 100 μA	MIN to MAX			0.2	V
	I _{OL} = 12 mA	2.7 V			0.4	
	I _{OL} = 24 mA	3 V			0.55	
I _I	V _I = V _{CC} or GND	3.6 V			±5	μA
I _{OZ}	V _O = V _{CC} or GND	3.6 V			±10	μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	3.6 V			20	μA
ΔI _{CC}	V _{CC} = 3 V to 3.6 V, Other inputs at V _{CC} or GND, One input at V _{CC} - 0.6 V,				500	μA
C _i	V _I = V _{CC} or GND	3.3 V	TBD			pF
C _o	V _O = V _{CC} or GND	3.3 V	TBD			pF

‡ For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

PRODUCT PREVIEW

